



APR 2 9 2003 TC 1700 ATTENTION: BOX AFTER FINAL RESPONSE UNDER 37 C.F.R. § 1.116 EXPEDITED PROCEDURE REQUESTED EXAMINING GROUP 1722

PATENT Customer No. 22,852 Attorney Docket No. 04329.2230

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Kenji HASHIMOTO

Application No.: 09/503,170

Filed: February 14, 2000

For: RESIN ENCAPSULATING
APPARATUS AND METHOD

Group Art Unit: 1722

Examiner: R. Davis

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USED IN A MANUFACTURE OF A

SEMICONDUCTOR DEVICE

Assistant Commissioner for Patents Washington, DC 20231

Sir:

AMENDMENT AFTER FINAL

In reply to the Final Office Action of January 24, 2003, and pursuant to 37 C.F.R. § 1.116, Applicant proposes that this application be amended as follows:

IN THE CLAIMS:

Please amend claims 1 and 8, as follows:

FINNEGAN HENDERSON FARABOW GARRETT &

DUNNER LLP 1300 I Street, NW Washington, DC 20005 202.408.4000 Fax 202.408.4400

www.finnegan.com

1. (Twice Amended) A resin encapsulating apparatus comprising:

a retaining section which petains a semiconductor device;